September 2015

FAN73611_OP — Single-Channel High-Side Gate Drive IC



FAN73611 OP Single-Channel High-Side Gate Drive IC

Features

- Floating Channel for Bootstrap Operation to +600V
- 250 mA/500 mA Sourcing/Sinking Current Driving Capability
- Common-Mode dv/dt Noise-Canceling Circuit
- 3.3 V and 5 V Input Logic Compatible
- Output In Phase with Input Signal
- Under-Voltage Lockout for V_{DD} and V_{BS}
- 8-Lead Small Outline Package (SOP)

The FAN73611 OP is a monolithic high-side gate drive IC that can drive MOSFETs and IGBTs operating up to +600 V. Fairchild's high-voltage process and commonmode noise canceling techniques provide stable operation of the high-side driver under high dv/dt noise circumstances. An advanced level-shift circuit offers high-side gate driver operation up to V_S=-9.8 V (typical) for V_{BS}=15 V. The UVLO circuits prevents malfunction when V_{DD} or V_{BS} is lower than the specified threshold voltage. The output drivers typically source/sink 250 mA/500 mA; respectively, which is suitable for Plasma Display Panel (PDP) application, motor drive inverter, and switching mode power supply applications.

Applications

PDP Scan Driver

- Motor Driver
- Switching-Mode Power Supply (SMPS)

Related Application Notes

- AN-6076 Design and Application Guide of Boostrap Circuit for High-Voltage Gate-Drive IC
- <u>AN-9052</u> <u>Design Guide for</u> <u>Selection of Bootstrap</u> Components
- AN-8102 Recommendations to Avoid Short Pulse Width Issues in HVIC Gate Driver Applications

Description

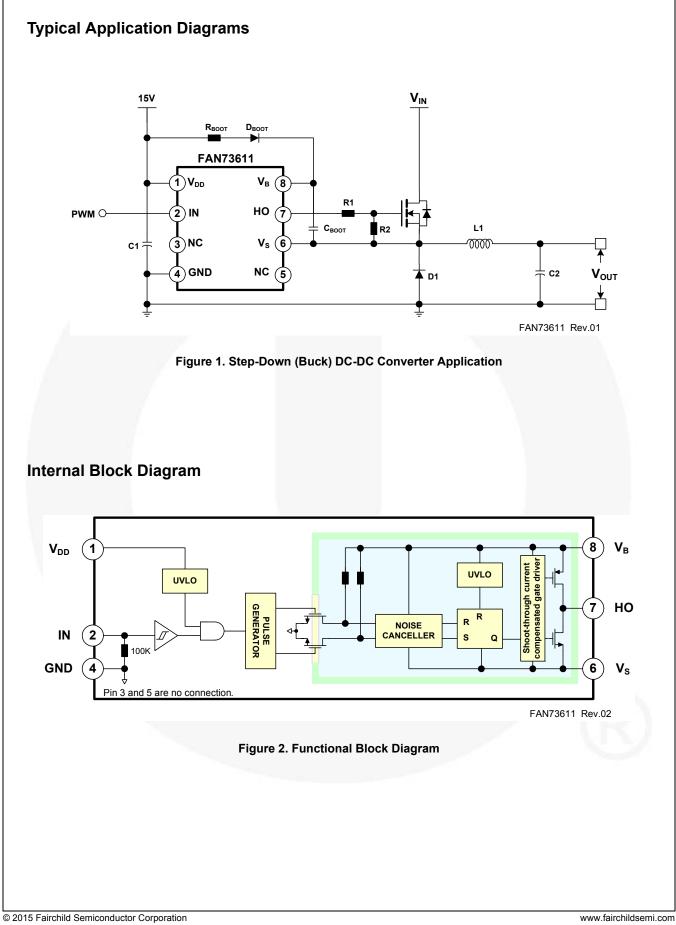
Ordering Information

Part Number	Package	Operating Temperature	Packing Method	Description
FAN73611MX_OP ⁽¹⁾	8 SOP	-40°C ~ 125°C	Tape & Reel	General Application

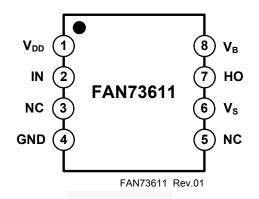
Note:

1. This device passed wave soldering test by JESD22A-111.





Pin Configuration





Pin Definitions

Pin #	Name	Description
1	V _{DD}	Supply Voltage
2	IN	Logic Input for High-Side Gate Driver Output
3	NC	No Connection
4	GND	Ground
5	NC	No Connection
6	V _S	High-Voltage Floating Supply Return
7	HO	High-Side Driver Output
8	V _B	High-Side Floating Supply

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A=25^{\circ}C$ unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
V _S	High-Side Floating Offset Voltage	V _B -25	V _B +0.3	V
V _B	High-Side Floating Supply Voltage	-0.3	625.0	V
V _{HO}	High-Side Floating Output Voltage	V _S -0.3	V _B +0.3	V
V _{DD}	Low-Side and Logic Supply Voltage	-0.3	25.0	V
V _{IN}	Logic Input Voltage	-0.3	V _{DD} +0.3	V
dV _S /dt	Allowable Offset Voltage Slew Rate		± 50	V/ns
PD	Power Dissipation ^(2, 3, 4)		0.625	W
θ_{JA}	Thermal Resistance		200	°C/W
ТJ	Junction Temperature	-55	+150	°C
T _{STG}	Storage Temperature	-55	+150	°C

Notes:

- 2. Mounted on 76.2 x 114.3 x 1.6 mm PCB (FR-4 glass epoxy material).
- 3. Refer to the following standards: JESD51-2: Integrated circuits thermal test method environmental conditions, natural convection, and JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages.
- 4. Do not exceed power dissipation (P_D) under any circumstances.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
V _B	High-Side Floating Supply Voltage	V _S +10	V _S +20	V
V _S	High-Side Floating Supply Offset Voltage	6-V _{DD}	600	V
V _{HO}	High-Side Output Voltage	V _S	V _B	V
V _{IN}	Logic Input Voltage	GND	V _{DD}	V
V _{DD}	Supply Voltage	10	20	V
T _A	Operating Ambient Temperature	-40	+125	°C

Electrical Characteristics

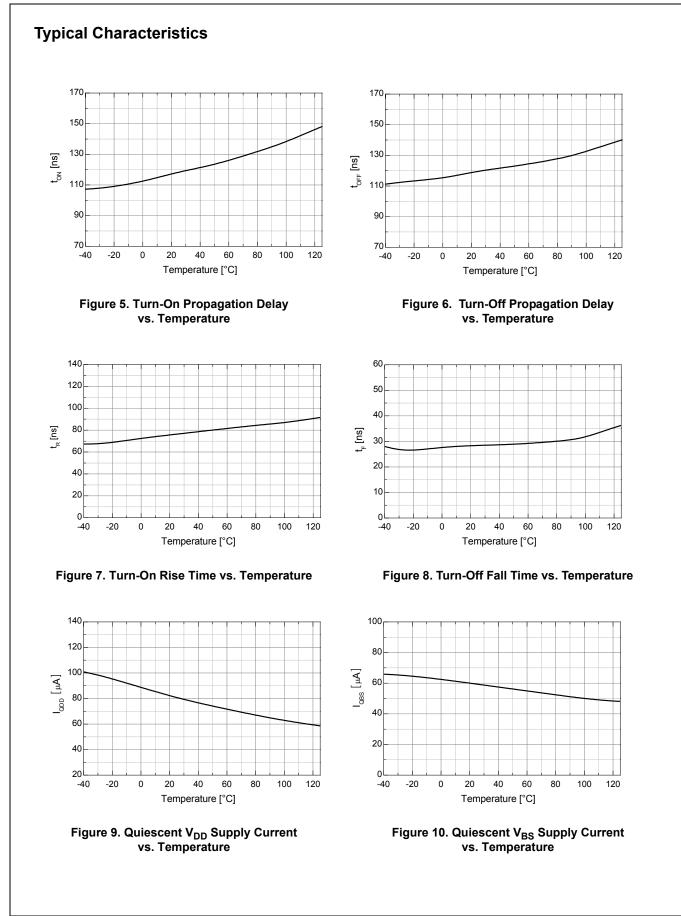
 $V_{BIAS}(V_{DD}, V_{BS}) = 15.0 \text{ V}$ and $T_A = 25^{\circ}\text{C}$ unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to GND. The V_O and I_O parameters are relative to V_S and are applicable to the respective output HO.

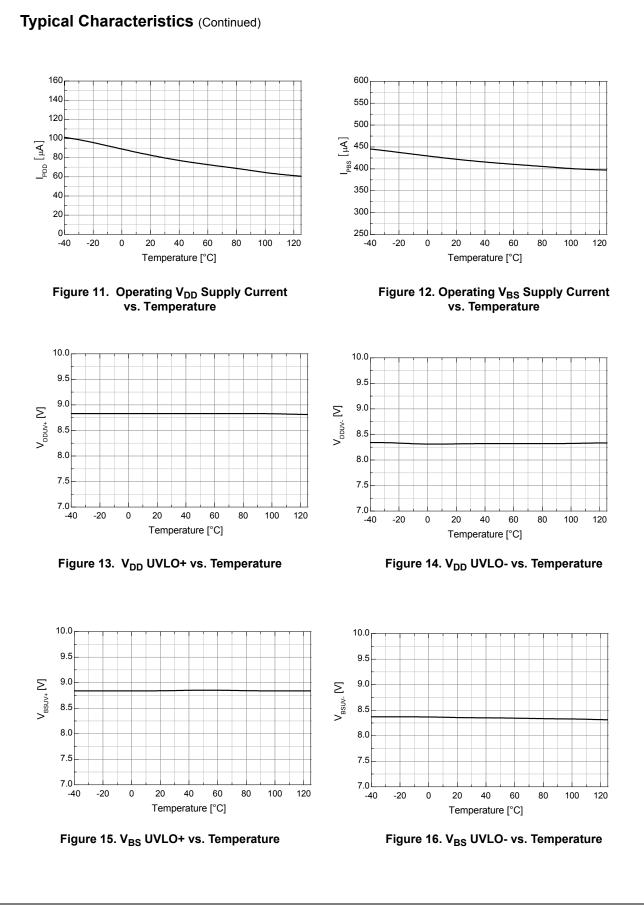
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Power Su	ipply Section					1
I _{QDD}	Quiescent V _{DD} Supply Current	V _{IN} =0 V or 5 V, C _{LOAD} =1000 pF		80	140	μA
I _{PDD}	Operating V _{DD} Supply Current	C _{LOAD} =1000 pF, f _{IN} =20 KHz, RMS value		80	160	μA
V _{DDUV+} V _{BSUV+}	V_{DD} and V_{BS} Supply Under-Voltage Positive Going Threshold Voltage	V _{DD} =Sweep, V _{BS} =Sweep	7.8	8.8	9.8	V
V _{DDUV-} V _{BSUV-}	V _{DD} and V _{BS} Supply Under-Voltage Nega- tive Going Threshold Voltage	V _{DD} =Sweep, V _{BS} =Sweep	7.3	8.3	9.3	V
V _{DDHYS} V _{BSHYS}	V_{DD} and V_{BS} Supply Under-Voltage Lockout Hysteresis Voltage	V _{DD} =Sweep, V _{BS} =Sweep		0.5		V
I _{LK}	Offset Supply Leakage Current	V _B =V _S =600 V			10	μA
I _{QBS}	Quiescent V _{BS} Supply Current	V _{IN} =0 V or 5 V, C _{LOAD} =1000 pF		60	100	μA
I _{PBS}	Operating V _{BS} Supply Current	C _{LOAD} =1000 pF, f _{IN} =20 KHz, RMS Value		420	600	μA
Input Log	ic Section					
V _{IH}	Logic "1" Input Voltage		2.5			V
V _{IL}	Logic "0" Input Voltage				0.8	V
I _{IN+}	Logic Input High Bias Current	V _{IN} =5 V		50	75	μA
I _{IN-}	Logic Input Low Bias Current	V _{IN} =0 V			2	μA
R _{IN}	Input Pull-Down Resistance		60	100		KΩ
Gate Driv	er Output Section					
V _{OH}	High Level Output Voltage ($V_{BIAS} - V_O$)	No Load	j.		0.1	V
V _{OL}	Low Level Output Voltage	No Load	-C		0.1	V
I _{O+}	Output High, Short-Circuit Pulsed Current	V _{HO} =0 V, V _{IN} =5 V, PW ≤10 µs	200	250		mA
I _{O-}	Output Low, Short-Circuit Pulsed Current	V _{HO} =15 V,V _{IN} =0 V, PW ≤10 µs	400	500		mA
V _S	Allowable Negative V_S Pin Voltage for IN Signal Propagation to HO	V _{BS} =15 V		-9.8	-7.0	V

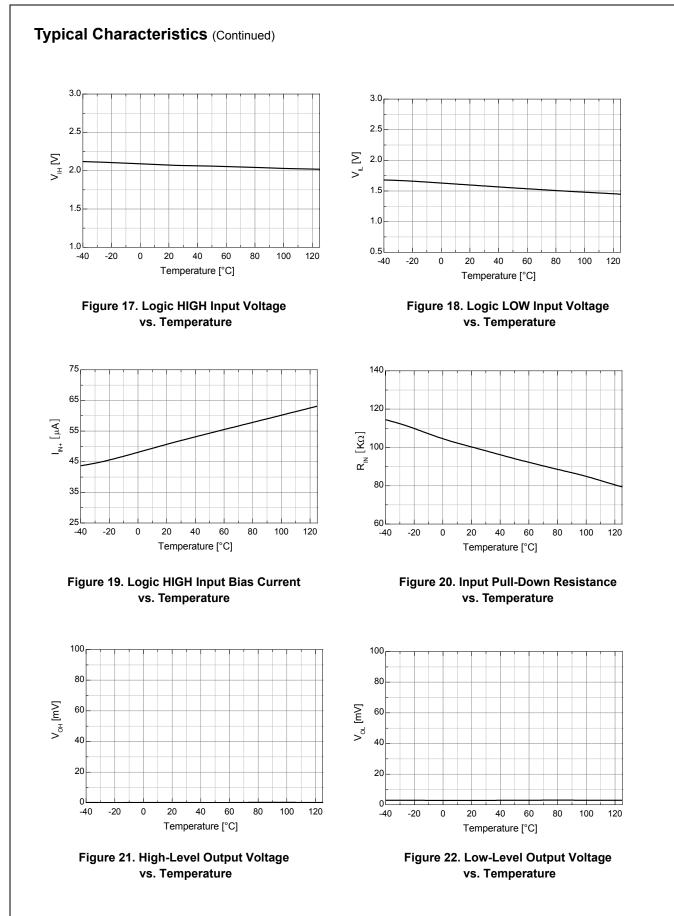
Dynamic Electrical Characteristics

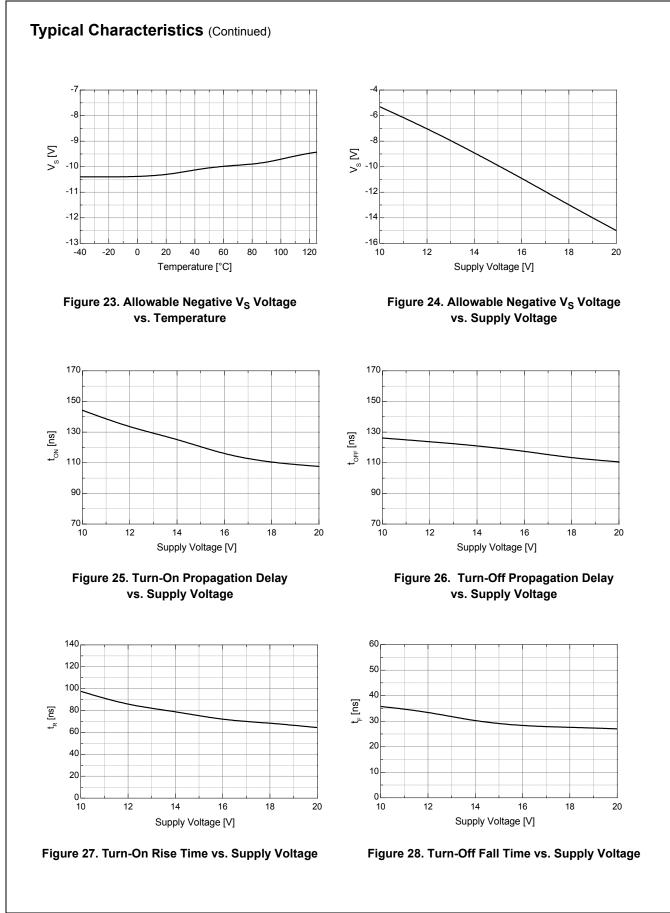
 $V_{DD}\text{=}V_{BS}\text{=}15$ V, $C_{LOAD}\text{=}1000$ pF, and $T_{A}\text{=}25^{\circ}\text{C},$ unless otherwise specified.

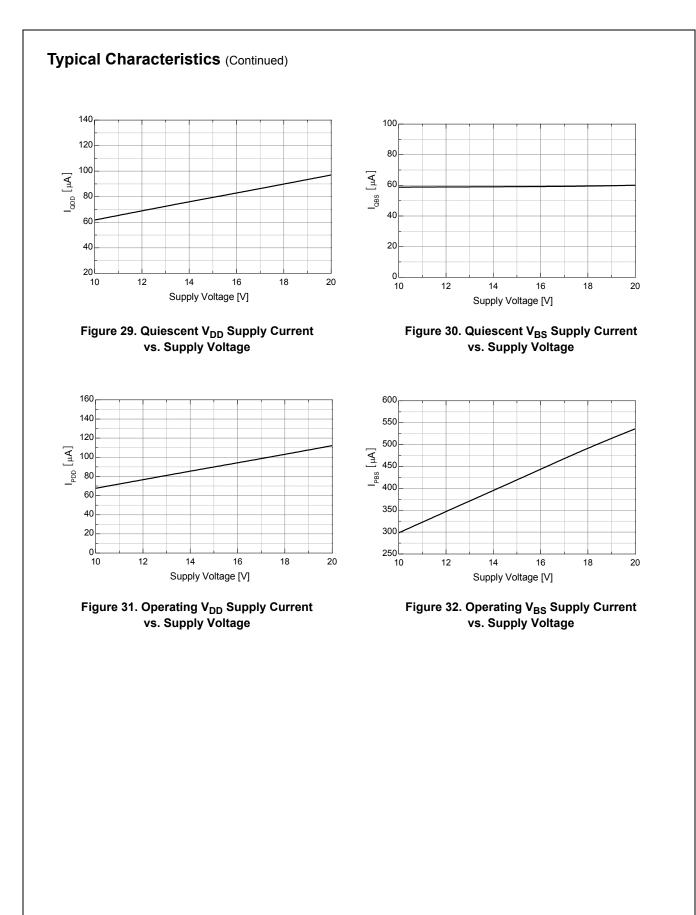
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t _{on}	Turn-On Propagation Delay Time	V _S =0 V	70	120	170	ns
t _{off}	Turn-Off Propagation Delay Time	V _S =0 V	70	120	170	ns
t _r	Turn-On Rise Time			70	140	ns
t _f	Turn-Off Fall Time			30	60	ns

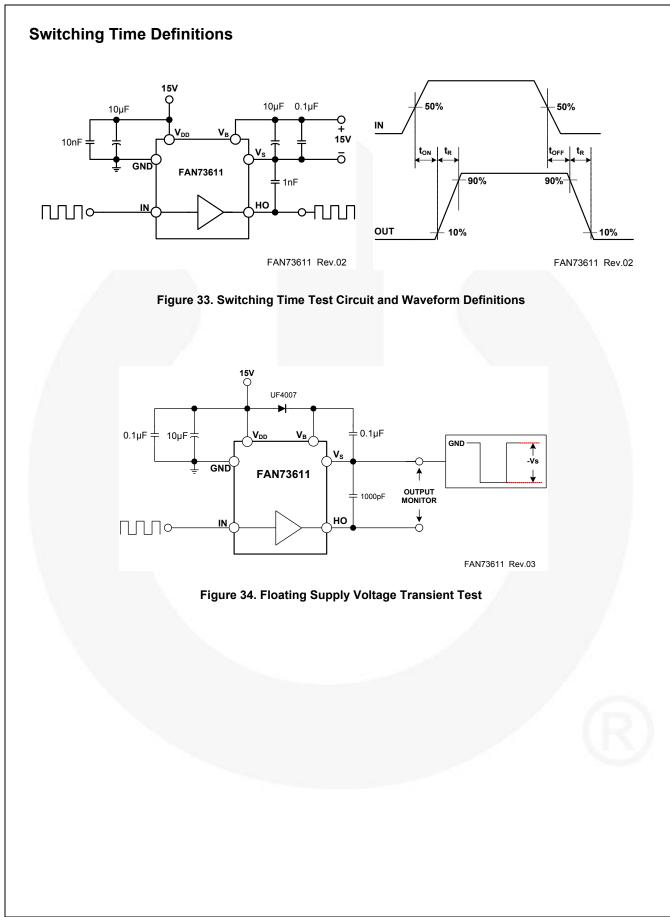




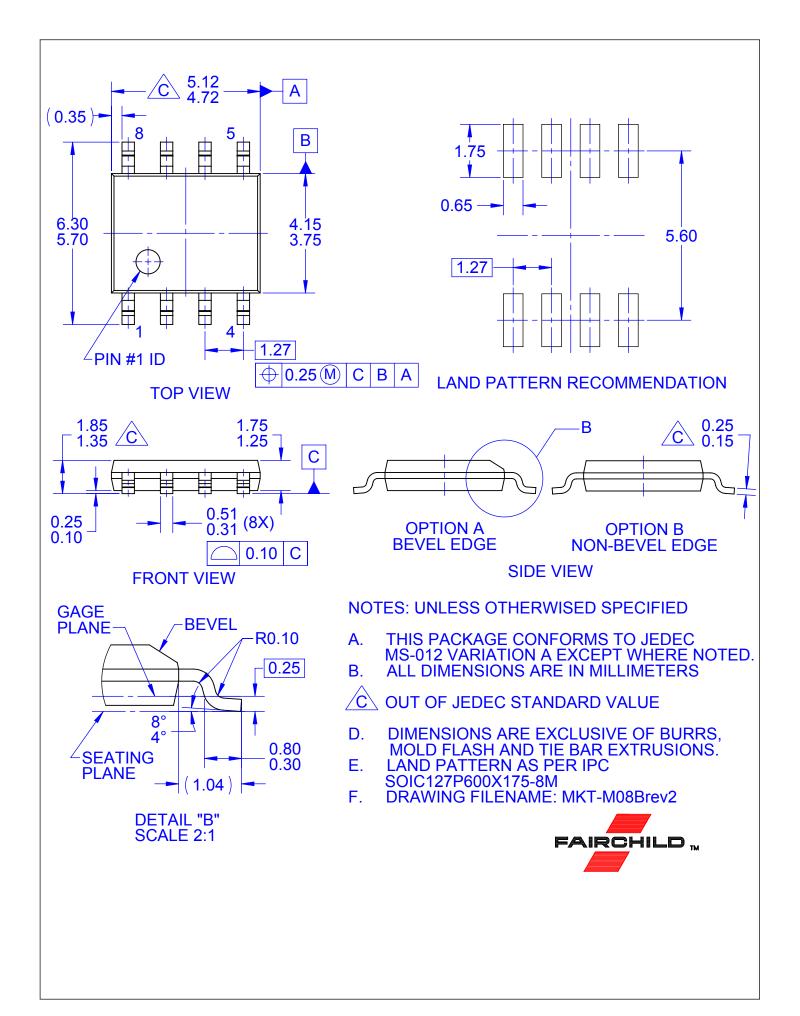








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